

General Description

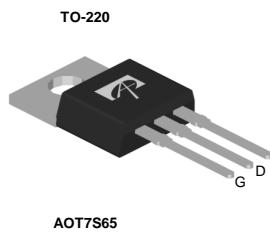
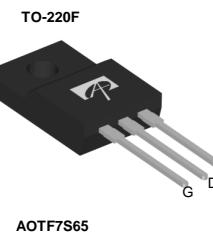
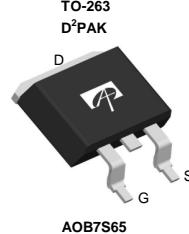
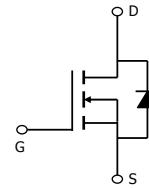
The AOT7S65 & AOB7S65 & AOTF7S65 have been fabricated using the advanced α MOS™ high voltage process that is designed to deliver high levels of performance and robustness in switching applications. By providing low $R_{DS(on)}$, Q_g and E_{oss} along with guaranteed avalanche capability these parts can be adopted quickly into new and existing offline power supply designs.

For Halogen Free add "L" suffix to part number:
 AOT7S65L & AOB7S65L & AOTF7S65L

Product Summary

V_{DS} @ $T_{j,max}$	750V
I_{DM}	30A
$R_{DS(ON),max}$	0.65Ω
$Q_{g,typ}$	9.2nC
E_{oss} @ 400V	2μJ

100% UIS Tested
 100% R_g Tested


Top View

AOT7S65

AOTF7S65

AOB7S65

Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOT7S65/AOB7S65	AOTF7S65	AOTF7S65L	Units
Drain-Source Voltage	V_{DS}		650		V
Gate-Source Voltage	V_{GS}		± 30		V
Continuous Drain Current	$T_C=25^\circ\text{C}$	I_D	7	7*	A
Current			5	5*	
Pulsed Drain Current ^C	I_{DM}		30		
Avalanche Current ^C	I_{AR}		1.7		A
Repetitive avalanche energy ^C	E_{AR}		43		mJ
Single pulsed avalanche energy ^G	E_{AS}		86		mJ
Power Dissipation ^B	$T_C=25^\circ\text{C}$	P_D	104	35	W
Derate above 25°C			0.8	0.3	W/°C
MOSFET dv/dt ruggedness	dv/dt		100		V/ns
Peak diode recovery dv/dt ^H			20		
Junction and Storage Temperature Range	T_J, T_{STG}		-55 to 150		°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds ^J	T_L		300		°C

Thermal Characteristics

Parameter	Symbol	AOT7S65/AOB7S65	AOTF7S65	AOTF7S65L	Units
Maximum Junction-to-Ambient ^{A,D}	R_{JJA}	65	65	65	°C/W
Maximum Case-to-sink ^A	R_{ICS}	0.5	--	--	°C/W
Maximum Junction-to-Case	R_{JJC}	1.2	3.6	4.7	°C/W

* Drain current limited by maximum junction temperature.

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V, T _J =25°C	650	-	-	V
		I _D =250μA, V _{GS} =0V, T _J =150°C	700	750	-	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =650V, V _{GS} =0V	-	-	1	μA
		V _{DS} =520V, T _J =150°C	-	10	-	
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±30V	-	-	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =5V, I _D =250μA	2.6	3.3	4	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =3.5A, T _J =25°C	-	0.54	0.65	Ω
		V _{GS} =10V, I _D =3.5A, T _J =150°C	-	1.48	1.64	Ω
V _{SD}	Diode Forward Voltage	I _S =3.5A, V _{GS} =0V, T _J =25°C	-	0.82	-	V
I _S	Maximum Body-Diode Continuous Current		-	-	7	A
I _{SM}	Maximum Body-Diode Pulsed Current ^C		-	-	30	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz	-	434	-	pF
C _{oss}	Output Capacitance		-	30	-	pF
C _{o(er)}	Effective output capacitance, energy related ^H	V _{GS} =0V, V _{DS} =0 to 480V, f=1MHz	-	23	-	pF
C _{o(tr)}	Effective output capacitance, time related ^I		-	80	-	pF
C _{rss}	Reverse Transfer Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz	-	1	-	pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	-	17.5	-	Ω
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} =10V, V _{DS} =480V, I _D =3.5A	-	9.2	-	nC
Q _{gs}	Gate Source Charge		-	2.5	-	nC
Q _{gd}	Gate Drain Charge		-	2.7	-	nC
t _{D(on)}	Turn-On DelayTime	V _{GS} =10V, V _{DS} =400V, I _D =3.5A, R _G =25Ω	-	21	-	ns
t _r	Turn-On Rise Time		-	14	-	ns
t _{D(off)}	Turn-Off DelayTime		-	55	-	ns
t _f	Turn-Off Fall Time		-	15	-	ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =3.5A, dI/dt=100A/μs, V _{DS} =400V	-	224	-	ns
I _{rm}	Peak Reverse Recovery Current	I _F =3.5A, dI/dt=100A/μs, V _{DS} =400V	-	19	-	A
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =3.5A, dI/dt=100A/μs, V _{DS} =400V	-	2.8	-	μC

A. The value of R_{θJA} is measured with the device in a still air environment with T_A=25°C.

B. The power dissipation P_D is based on T_{J(MAX)=150°C}, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)=150°C}, Ratings are based on low frequency and duty cycles to keep initial T_J=25°C.

D. The R_{θJA} is the sum of the thermal impedance from junction to case R_{θJC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)=150°C}. The SOA curve provides a single pulse rating.

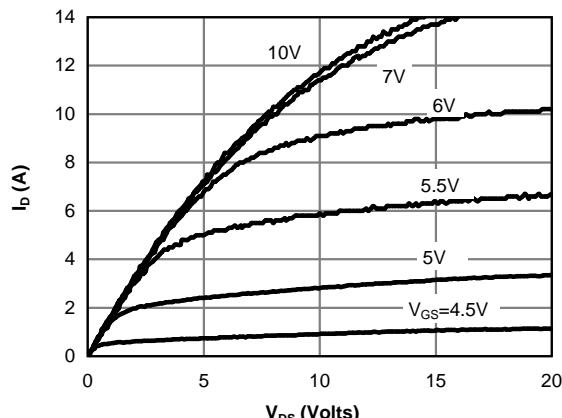
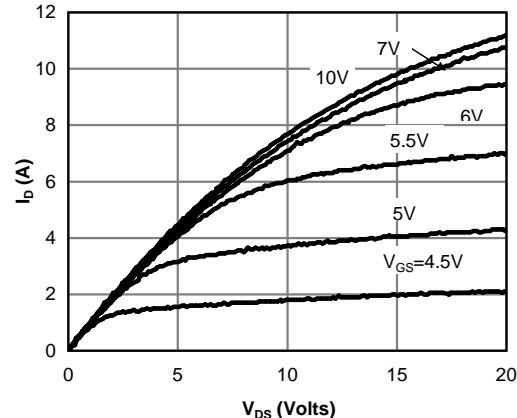
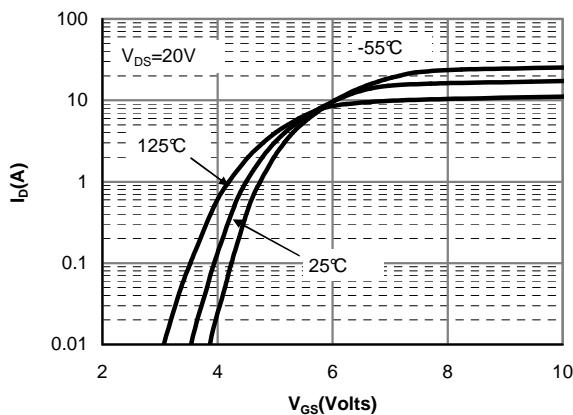
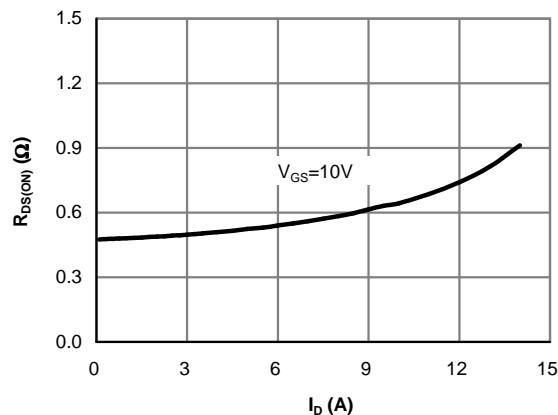
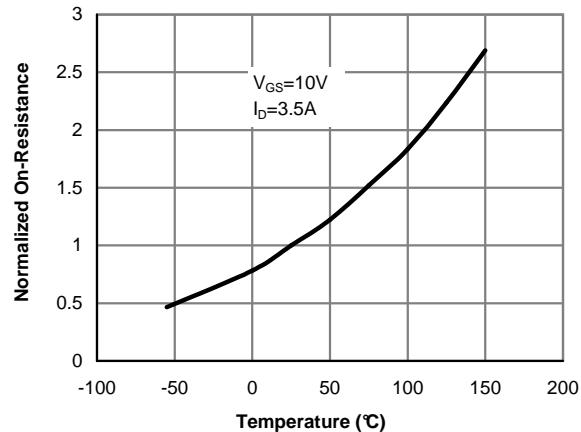
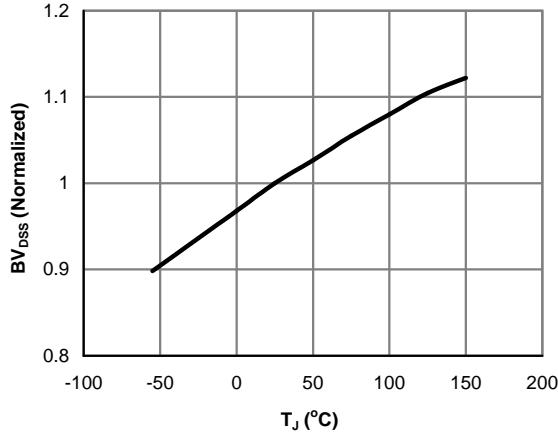
G. L=60mH, I_{AS}=1.7A, V_{DD}=150V, Starting T_J=25°C

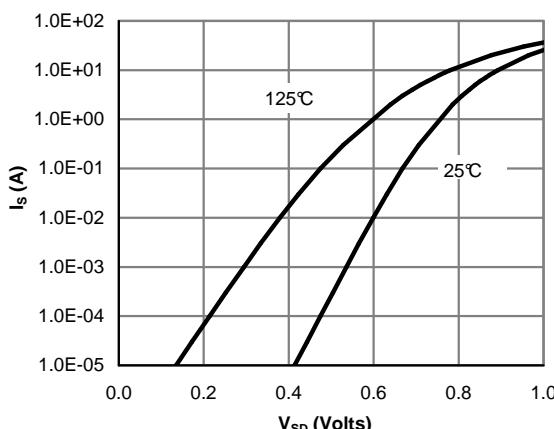
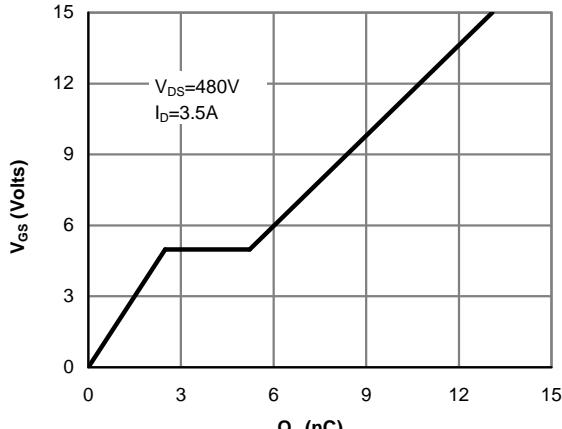
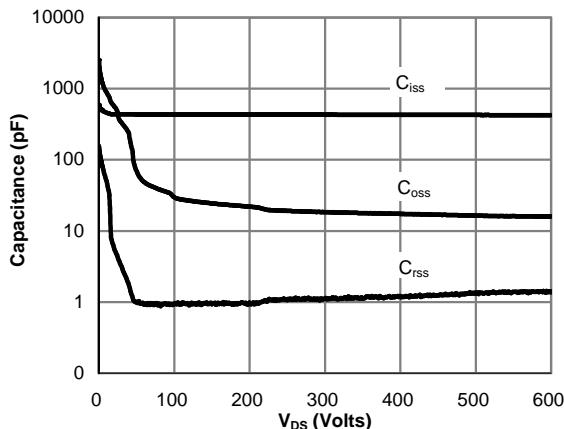
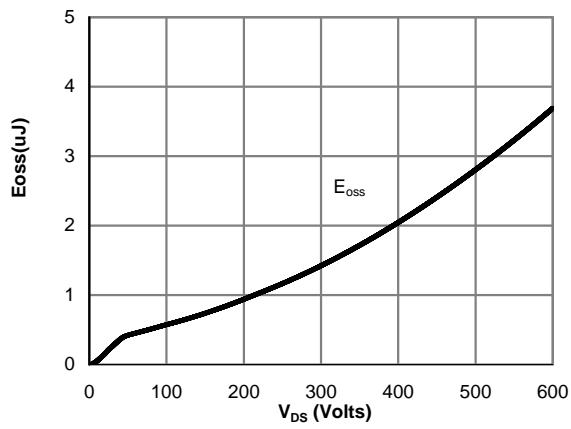
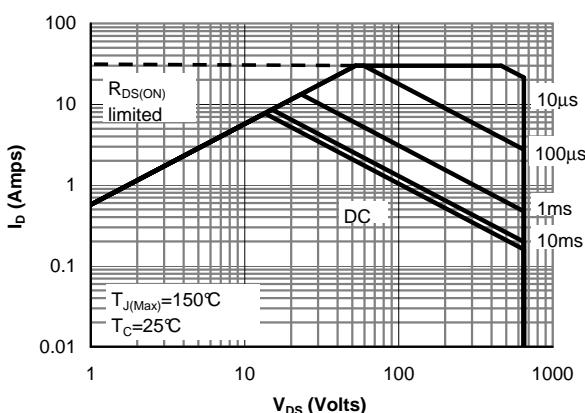
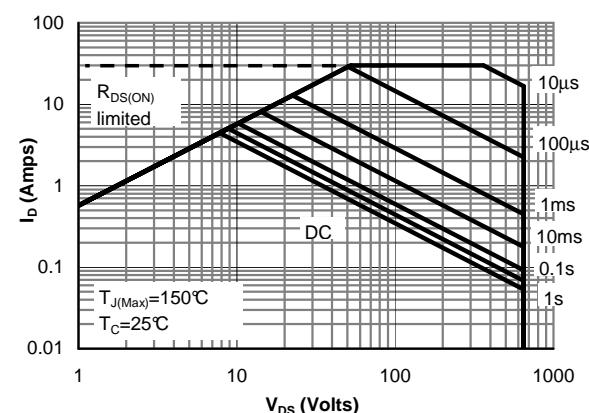
H. C_{o(er)} is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}.

I. C_{o(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}.

J. Wavesoldering only allowed at leads.

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 1: On-Region Characteristics@25°C

Figure 2: On-Region Characteristics@125°C

Figure 3: Transfer Characteristics

Figure 4: On-Resistance vs. Drain Current and Gate Voltage

Figure 5: On-Resistance vs. Junction Temperature

Figure 6: Break Down vs. Junction Temperature

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 7: Body-Diode Characteristics (Note E)

Figure 8: Gate-Charge Characteristics

Figure 9: Capacitance Characteristics

Figure 10: Coss stored Energy

Figure 11: Maximum Forward Biased Safe Operating Area for AOT(B)7S65 (Note F)

Figure 12: Maximum Forward Biased Safe Operating Area for AOTF7S65 (Note F)

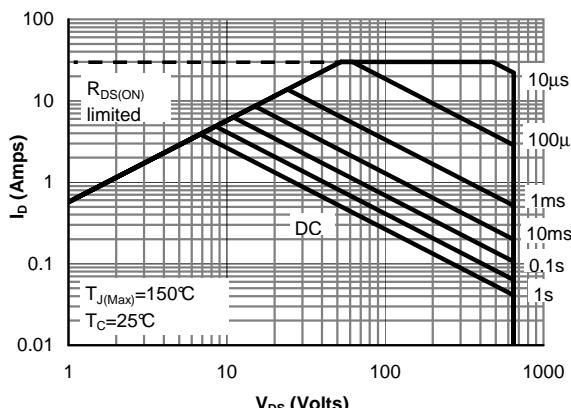
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Figure 13: Maximum Forward Biased Safe Operating Area for AOTF7S65L (Note F)

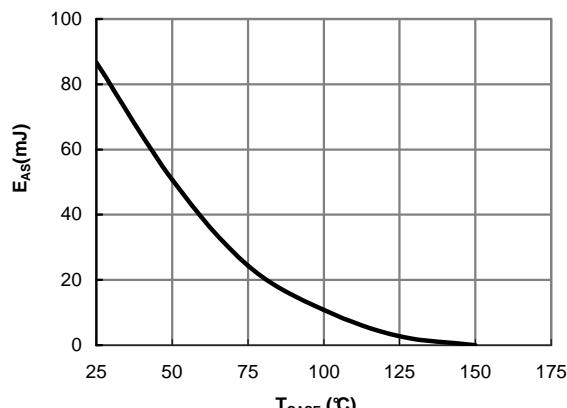


Figure 14: Avalanche energy

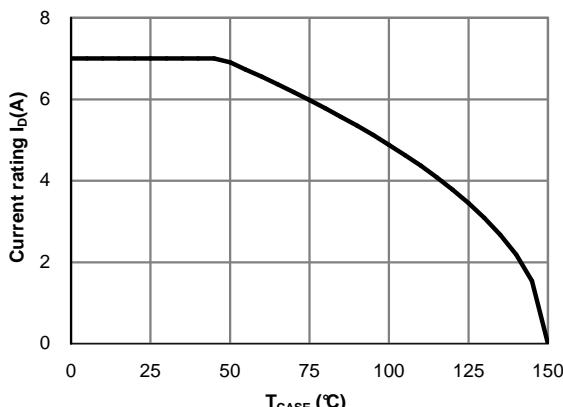


Figure 15: Current De-rating (Note B)

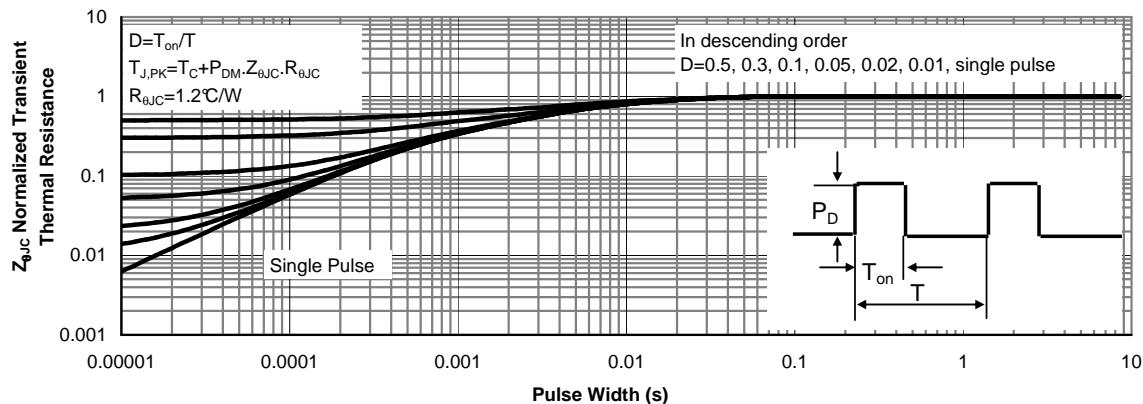
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Figure 16: Normalized Maximum Transient Thermal Impedance for AOT(B)7S65 (Note F)

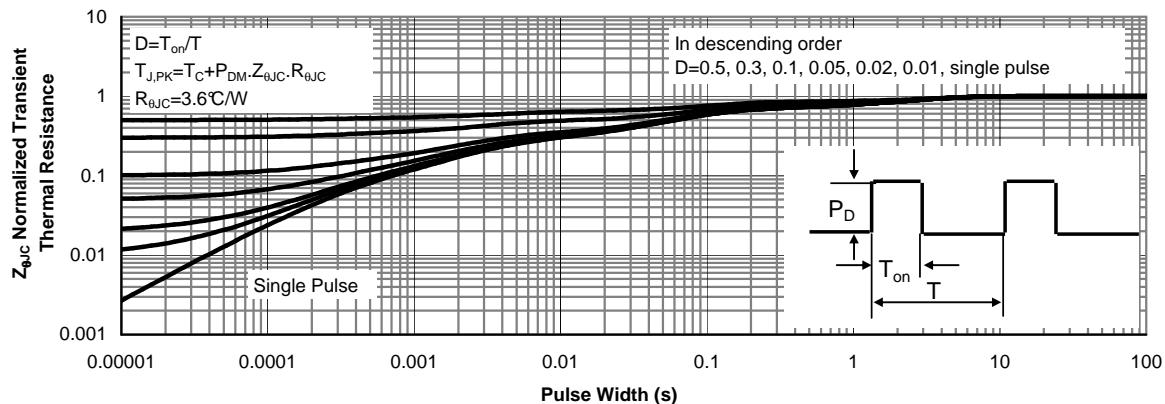


Figure 17: Normalized Maximum Transient Thermal Impedance for AOTF7S65 (Note F)

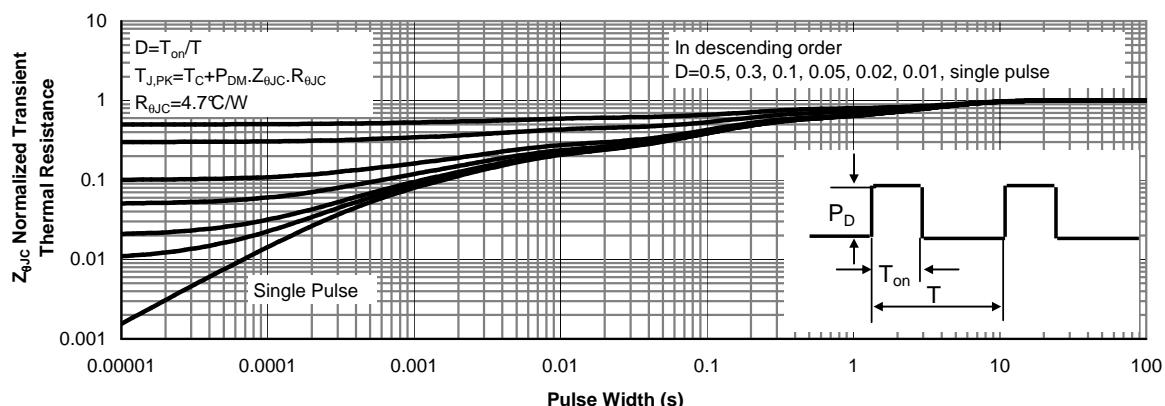
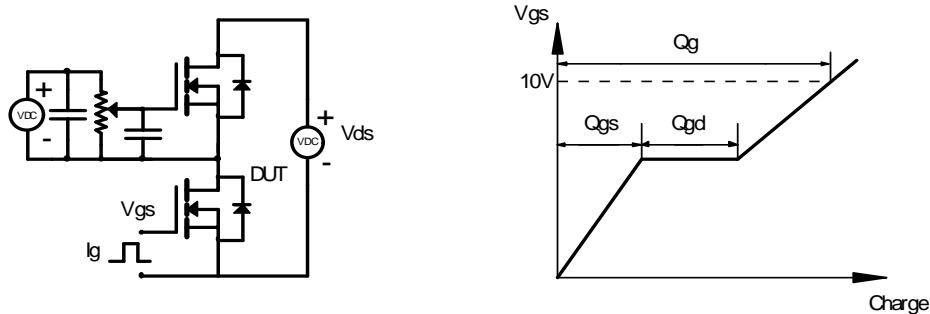
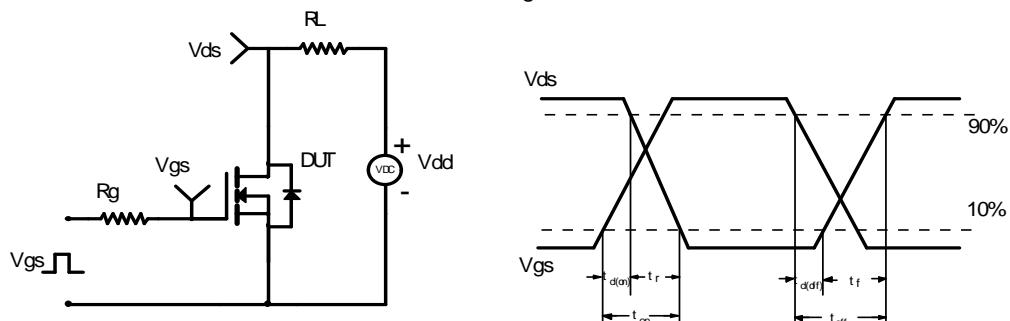
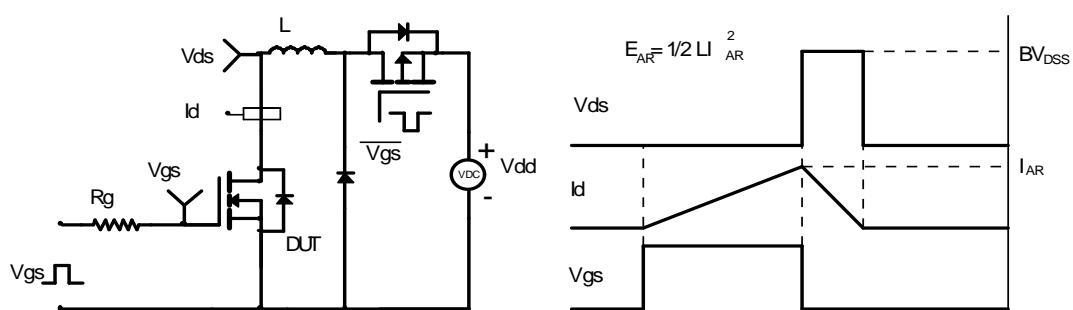
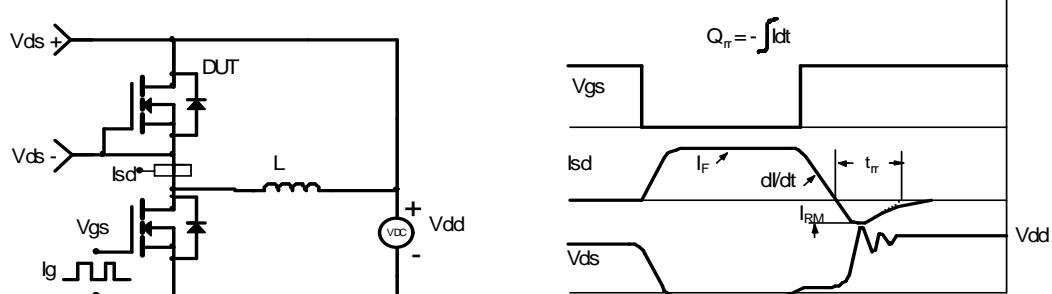


Figure 18: Normalized Maximum Transient Thermal Impedance for AOTF7S65L (Note F)


Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveforms

Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

Diode Recovery Test Circuit & Waveforms


X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by Alpha & Omega manufacturer:

Other Similar products are found below :

[IRFD120](#) [JANTX2N5237](#) [BUK455-60A/B](#) [MIC4420CM-TR](#) [VN1206L](#) [NDP4060](#) [SI4482DY](#) [IPS70R2K0CEAKMA1](#) [SQD23N06-31L-GE3](#)
[TK16J60W,S1VQ\(O](#) [2SK2614\(TE16L1,Q\)](#) [DMN1017UCP3-7](#) [DMN1053UCP4-7](#) [SQJ469EP-T1-GE3](#) [NTE2384](#) [DMC2700UDMQ-7](#)
[DMN2080UCB4-7](#) [DMN61D9UWQ-13](#) [US6M2GTR](#) [DMN31D5UDJ-7](#) [DMP22D4UFO-7B](#) [DMN1006UCA6-7](#) [DMN16M9UCA6-7](#)
[STF5N65M6](#) [IRF40H233XTMA1](#) [STU5N65M6](#) [DMN6022SSD-13](#) [DMN13M9UCA6-7](#) [DMTH10H4M6SPS-13](#) [DMN2990UFB-7B](#)
[IPB80P04P405ATMA2](#) [2N7002W-G](#) [MCAC30N06Y-TP](#) [MCQ7328-TP](#) [NTMC083NP10M5L](#) [NVMFS2D3P04M8LT1G](#) [BXP7N65D](#)
[BXP4N65F](#) [AOL1454G](#) [WMJ80N60C4](#) [BXP2N20L](#) [BXP2N65D](#) [BXT1150N10J](#) [BXT1700P06M](#) [TSM60NB380CP](#) [ROG](#) [RQ7L055BGTCR](#)
[DMNH15H110SK3-13](#) [SLF10N65ABV2](#) [BSO203SP](#) [BSO211P](#)